

STD80N6F6

N-channel 60 V, 80 A STripFET™ VI DeepGATE™ Power MOSFET in DPAK package

Datasheet - preliminary data

Features

Order codes	V _{DSS}	R _{DS(on)} max	I _D
STD80N6F6	60 V	$6.5~\text{m}\Omega$	80 A ⁽¹⁾

- 1. Current limited by package
- Low gate charge
- Very low on-resistance
- High avalanche ruggedness

Applications

■ Switching applications

Description

This device is an N-channel Power MOSFET developed using the 6th generation of STripFET™ DeepGATE™ technology, with a new gate structure. The resulting Power MOSFET exhibits the lowest RDS(on) in all packages.

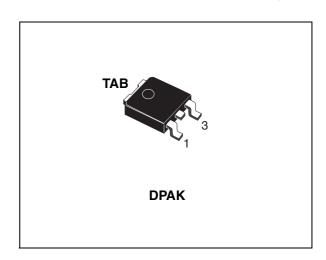


Figure 1. Internal schematic diagram

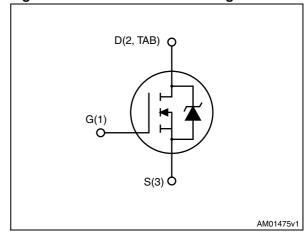


Table 1. Device summary

Order codes	Marking	Package	Packaging
STD80N6F6	80N6F6	DPAK	Tape and reel

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STD80N6F6 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	60	V
V _{GS}	Gate-source voltage	± 20	V
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	80	Α
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	80	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	320	Α
P _{TOT}	Total dissipation at T _C = 25 °C	120	W
	Derating factor	2	W/°C
T _{stg}	Storage temperature	- 55 to 175	
Tj	Operating junction temperature	- 55 10 175	°C

^{1.} Current limited by package

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	1.25	°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction - PCB max	50	°C/W

^{1.} When mounted on FR-4 board of 1 inch², 2 oz Cu

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage (V _{GS} = 0)	I _D = 250 μA	60			V
	Zero gate voltage	V _{DS} = 60 V			1	μΑ
I _{DSS}	Drain current (V _{GS} = 0)	$V_{DS} = 60 \text{ V}, T_{C} = 125 ^{\circ}\text{C}$			100	μΑ
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 20 V			± 100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	3		4.5	٧
R _{DS(on)}	Static drain-source on-resistance	V _{GS} = 10 V, I _D = 40 A		TBD	6.5	mΩ

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance			7480		pF
C _{oss}	Output capacitance	$V_{DS} = 25 \text{ V, f} = 1 \text{ MHz,}$	_	450	_	pF
C_{rss}	Reverse transfer capacitance	V _{GS} = 0		310		pF
Q_g	Total gate charge	V 00 V 1 00 A		122		nC
Q_{gs}	Gate-source charge	$V_{DD} = 30 \text{ V}, I_D = 80 \text{ A},$ $V_{GS} = 10 \text{ V}$	-	TBD	-	nC
Q_{gd}	Gate-drain charge	VGS - 10 V		TBD		nC

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r	Turn-on delay time Rise time	$V_{DD} = 30 \text{ V}, I_{D} = 40 \text{ A}$ $R_{G} = 4.7 \Omega V_{GS} = 10 \text{ V}$	-	TBD	-	ns ns
t _{d(off)}	Turn-off-delay time Fall time		-	TBD	-	ns ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
I _{SD}	Source-drain current		-		80	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		320	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 80 A, V _{GS} = 0	-		1.1	V
t _{rr}	Reverse recovery time	I _{SD} = 80 A, V _{DD} = 48 V				ns
Q_{rr}	Reverse recovery charge	di/dt = 100 A/μs,	-	TBD		nC
I _{RRM}	Reverse recovery current	T _j = 150 °C				Α

^{1.} Current limited by package

^{2.} Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

3 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

Table 8. DPAK (TO-252) mechanical data

	in (10-202) incondino	mm	
Dim.	Min.	Тур.	Max.
Α	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
С	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1		5.10	
E	6.40		6.60
E1		4.70	
е		2.28	
e1	4.40		4.60
Н	9.35		10.10
L	1		
L1		2.80	
L2		0.80	
L4	0.60		1
R		0.20	
V2	0°		8°

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Figure 2. DPAK (TO-252) drawing

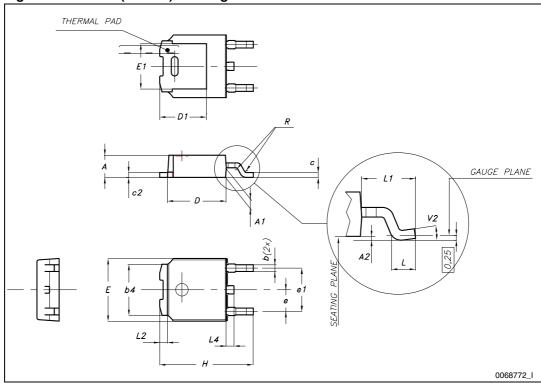
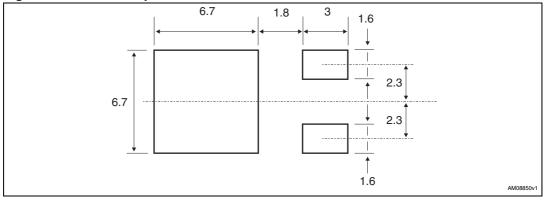


Figure 3. DPAK footprint^(a)



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a. All dimensions are in millimeters.

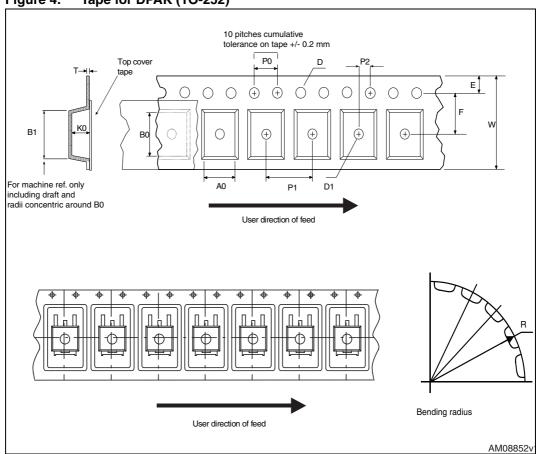
4 Packaging mechanical data

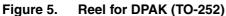
Table 9. DPAK (TO-252) tape and reel mechanical data

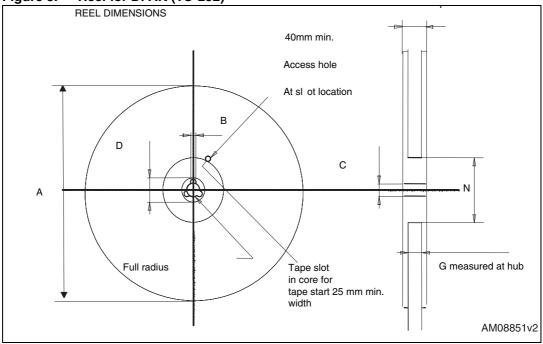
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	Таре			Reel	
Dim	m	ım	Dim.	m	nm
Dim.	Min.	Max.	Dim.	Min.	Max.
A0	6.8	7	Α		330
В0	10.4	10.6	В	1.5	
B1		12.1	С	12.8	13.2
D	1.5	1.6	D	20.2	
D1	1.5		G	16.4	18.4
Е	1.65	1.85	N	50	
F	7.4	7.6	Т		22.4
K0	2.55	2.75			
P0	3.9	4.1		Base qty.	2500
P1	7.9	8.1		Bulk qty.	2500
P2	1.9	2.1			•
R	40				
Т	0.25	0.35			
W	15.7	16.3			

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Figure 4. Tape for DPAK (TO-252)







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Revision history STD80N6F6

5 Revision history

Table 10. Document revision history

Date	Revision	Changes
08-Aug-2012	1	Initial release.

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